# SiSA96DN

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**Vishay Siliconix** 

RoHS

COMPLIANT

HALOGEN FREE

## N-Channel 30 V (D-S) MOSFET



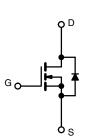
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0088				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_GS$ = 4.5 V	0.0120				
Q <sub>g</sub> typ. (nC)	9.9				
I <sub>D</sub> (A)	16 <sup>a, g</sup>				
Configuration	Single				

#### **FEATURES**

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- · Tuned for reducing transient spikes
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Synchronous buck converter
- High power density DC/DC
- Motor drive control
- Battery management
- · Load switch



N-Channel MOSFET

### **ORDERING INFORMATION**

Package	PowerPAK 1212-Single
Lead (Pb)-free and halogen-free	SiSA96DN-T1-GE3

PARAMETER Drain-source voltage		SYMBOL	LIMIT	UNIT
		V <sub>DS</sub>	30	v
Gate-source voltage		V <sub>GS</sub>	+20 / -16	v
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		16 <sup>a</sup>	
	T <sub>C</sub> = 70 °C	Ι.Γ	12 <sup>a</sup>	
	T <sub>A</sub> = 25 °C		14.8 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C	1 F	12 <sup>b, c</sup>	_
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	65	- A
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		16 <sup>a</sup>	
	T <sub>A</sub> = 25 °C	Is	3.2 <sup>b, c</sup>	
Single pulse avalanche current		I <sub>AS</sub>	15	
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	11.25	mJ
	T <sub>C</sub> = 25 °C		26.5	
Maximum power dissipation	T <sub>C</sub> = 70 °C		17	14/
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>, c</sup>	W
	T <sub>A</sub> = 70 °C	1 F	2.3 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	<u></u>
Soldering recommendations (peak temperature) <sup>c</sup>			260	- "

#### THERMAL RESISTANCE RATINGS SYMBOL TYPICAL PARAMETER MAXIMUM UNIT Maximum junction-to-ambient b $t \le 10 \text{ s}$ R<sub>thJA</sub> 28 35 °C/W Maximum junction-to-case (drain) Steady state R<sub>thJC</sub> 3.8 4.7

Notes Package limited. a.

b. Surface mounted on 1" x 1" FR4 board.

 $t = 10 \, s$ 

c. d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

e. f.

T<sub>C</sub> = 25 °C. g.

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SiSA96DN

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		· · · ·		•	•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	v
Drain-source breakdown voltage (transient) <sup>c</sup>	V <sub>DSt</sub>	$V_{GS} = 0 V$ , $I_{D(aval)} = 15 A$ , $t_{transient} = 50 ns$	36	-	-	v
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	I <sub>D</sub> =10 mA	-	13	-	
V <sub>GS(th)</sub> temperature coefficient	$\begin{array}{c c} & V_{GS(th)} & V_{DS} = V_{GS}, \\ \text{ige} & I_{GSS} & V_{DS} = 0 \text{ V}, V_{GS} \\ \text{drain current} & I_{DSS} & \frac{V_{DS} = 30 \text{ V}}{V_{DS} = 30 \text{ V}, V_{GS} \\ \text{rent }^{a} & I_{D(on)} & V_{DS} \ge 10 \text{ V}, \\ \text{tate resistance }^{a} & R_{DS(on)} & \frac{V_{GS} = 10 \text{ V}}{V_{GS} = 4.5 \text{ V}} \\ \text{ductance }^{a} & g_{fs} & V_{DS} = 15 \text{ V}, \\ \text{vse} & \frac{C_{iss}}{c_{oss}} \\ \text{apacitance} & C_{rss} & \end{array}$		-	-4.7	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	-	2.2	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = +20 / -16 V$	-	-	100	nA
	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μA
Zero gate voltage drain current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$	-	-	15	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30	-	-	Α
	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0073	0.0088	0
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0092	0.0120	Ω
Forward transconductance <sup>a</sup>	<b>g</b> <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	70	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	1385	-	
Output capacitance	Coss	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	478	-	pF
Reverse transfer capacitance			-	37	-	
Total acta abayra	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	20.5	31	nC
Total gate charge	Q <sub>g</sub> Q <sub>gs</sub>		-	9.9	15	
Gate-source charge		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	4.2	-	
Gate-drain charge	Q <sub>gd</sub>		-	2.5	-	
Gate resistance	Rg	f = 1 MHz	0.2	0.73	1.4	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	8	16	
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{I} = 1.5 \Omega, \text{ I}_{D} \cong 10 \text{ A},$	-	25	50	
Turn-off delay time	t <sub>d(off)</sub>	$V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$	-	13	26	1
Fall time	t <sub>f</sub>		-	9	18	
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	ns
Rise time	tr	V <sub>DD</sub> = 15 V, R <sub>L</sub> = 1.5 Ω, I <sub>D</sub> ≅ 10 A,	-	47	94	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	-	15	30	
Fall time			-	25	50	1
Drain-Source Body Diode Characteristics		· · · ·		•	•	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	16	•
Pulse diode forward current	I <sub>SM</sub>		-	-	50	A
dy diode voltage V <sub>SD</sub>		I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V	-	0.77	1.1	V
Body diode reverse recovery time	t <sub>rr</sub>		-	50	100	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs,	-	75	150	nC
Reverse recovery fall time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	43	-	ns
Reverse recovery rise time	t <sub>b</sub>	1	_	7	-	

#### Notes

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

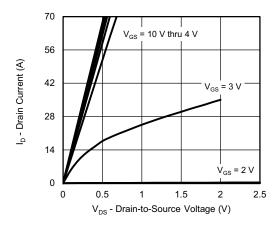
c. T<sub>CASE</sub> = 25 °C. Expected voltage stress during 100 % UIS test. Production datalog is not available.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

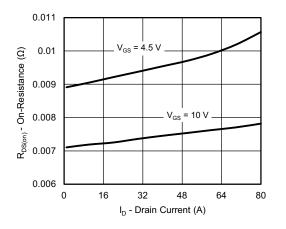
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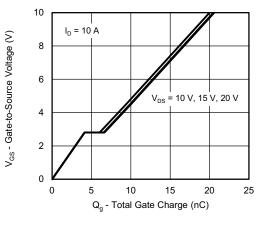
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



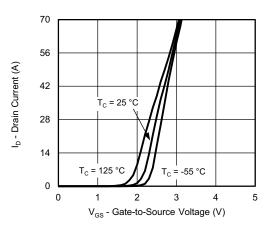
**Output Characteristics** 



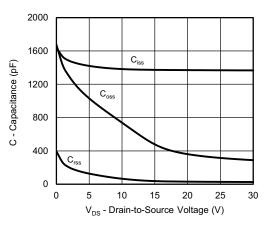
**On-Resistance vs. Drain Current and Gate Voltage** 



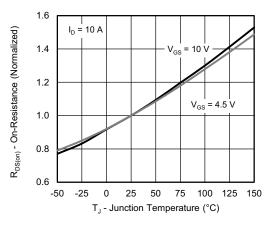
Gate Charge



**Transfer Characteristics** 



Capacitance



**On-Resistance vs. Junction Temperature** 

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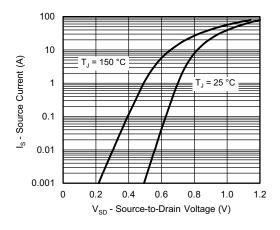
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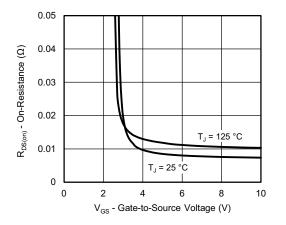
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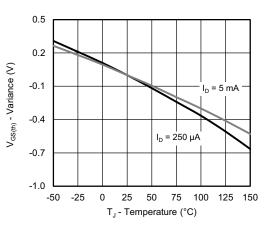
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



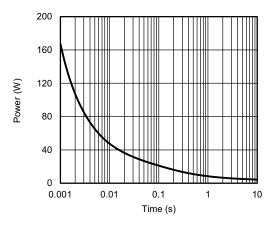
Source-Drain Diode Forward Voltage



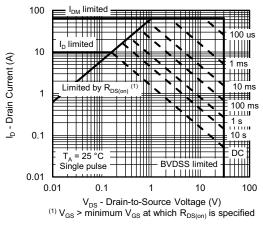
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



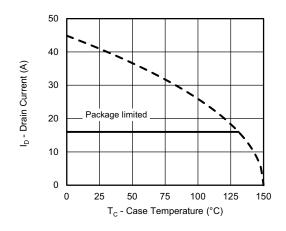
Safe Operating Area, Junction-to-Ambient

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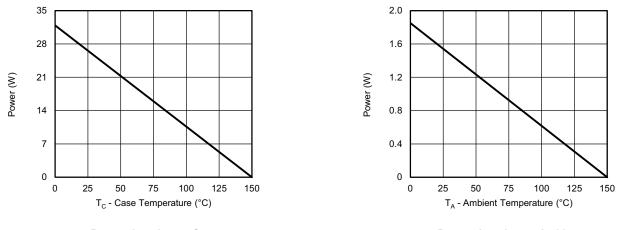
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

Power, Junction-to-Ambient

#### Note

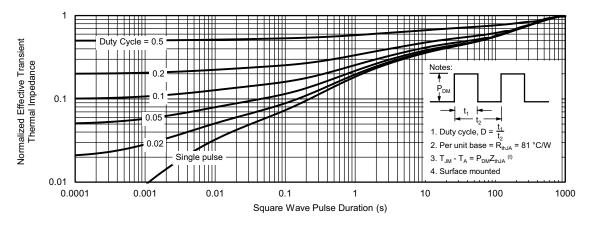
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



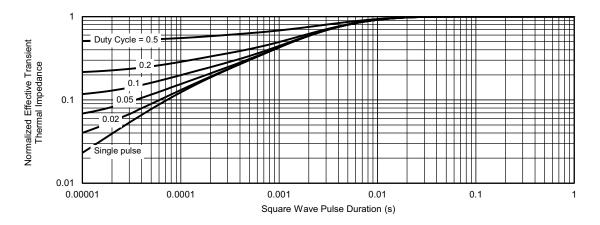
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

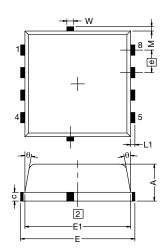
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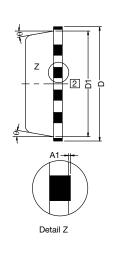
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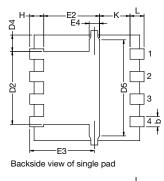


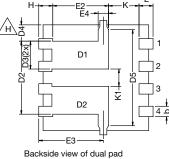
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# PowerPAK® 1212-8, (Single / Dual)









Notes

1. Inch will govern

Dimensions exclusive of mold gate burrs
Dimensions exclusive of mold flash and cutting burrs

DIM.		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.		
А	0.97	1.04	1.12	0.038	0.041	0.044	
A1	0.00	-	0.05	0.000	-	0.002	
b	0.23	0.30	0.41	0.009	0.012	0.016	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	3.20	3.30	3.40	0.126	0.130	0.134	
D1	2.95	3.05	3.15	0.116	0.120	0.124	
D2	1.98	2.11	2.24	0.078	0.083	0.088	
D3	0.48	-	0.89	0.019	-	0.035	
D4		0.47 typ.	·	0.0185 typ			
D5		2.3 typ.		0.090 typ			
E	3.20	3.30	3.40	0.126	0.130	0.134	
E1	2.95	3.05	3.15	0.116	0.120	0.124	
E2	1.47	1.60	1.73	0.058	0.063	0.068	
E3	1.75	1.85	1.98	0.069	0.073	0.078	
E4	0.034 typ.			0.013 typ.			
е		0.65 BSC		0.026 BSC			
К		0.86 typ.			0.034 typ.		
K1	0.35	-	-	0.014	-	-	
Н	0.30	0.41	0.51	0.012	0.016	0.020	
L	0.30	0.43	0.56	0.012	0.017	0.022	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	-	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
М	0.125 typ.			0.005 typ.			
N: S16-2667-R /G: 5882	ev. M, 09-Jan-17						

Revison: 09-Jan-17

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### RECOMMENDED MINIMUM PADS FOR PowerPAK<sup>®</sup> 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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